

CoreDDR v4.0

Handbook



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Printed in the United States of America

Part Number: 50200109-2

Release: July 2009

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Introduction

General Description

CoreDDR provides a high-performance interface to double data rate (DDR) synchronous dynamic random access memory (SDRAM) devices. CoreDDR accepts *read* and *write* commands using the simple local bus interface and translates these requests to the command sequences required by SDRAM devices. CoreDDR also performs all initialization and refresh functions.

CoreDDR uses bank management techniques to monitor the status of each SDRAM bank. Banks are only opened or closed when necessary, minimizing access delays. Up to four banks can be managed at one time. Access cascading is also supported, allowing read or write requests to be chained together. This results in no delay between requests, enabling up to 100% memory throughput for sequential accesses.

Key Features

CoreDDR is a highly configurable core and has the following features:

- High performance, double data rate controller for standard SDRAM chips and DIMMs
- Synchronous interface, fully pipelined internal architecture
- Supports up to 1,024 MB of memory
- Bank management logic monitors status of up to four SDRAM banks

Supported Device Families

- ProASIC3®E
- Fusion

Core Versions

This handbook applies to CoreDDR v4.0.

CoreDDR Device Utilization and Performance

Table 1 gives device utilization and performance for Actel CoreDDR.

Table 1 · CoreDDR Device Utilization and Performance

Family		Cells or Tiles	Utilization			Performance	
	Sequential	Combinatorial	Total	Device	Total	Terrormance	
ProASIC3E	795	953	1,748	A3PE600-2	12%	133 MHz	
Fusion	795	953	1,748	AFS600-2	12%	133 MHz	

Note: All data was obtained using a typical system configuration with the local bus tied to internal user logic and the controller configuration inputs hardcoded during synthesis.



Functional Block Description

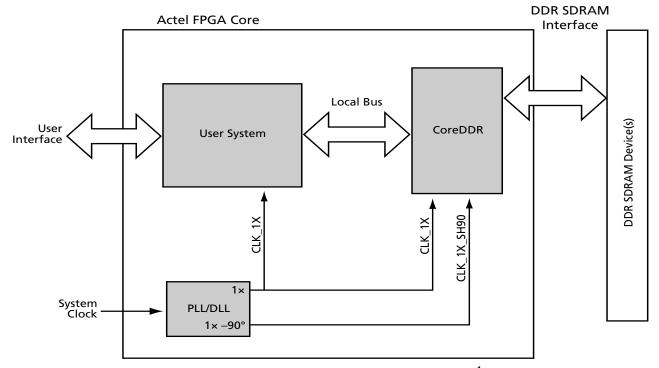


Figure 1-1 · Typical CoreDDR System¹

CoreDDR is provided with runtime-programmable inputs for all timing parameters (CAS latency, t_{RAS}, t_{RC}, t_{RFC}, t_{RCD}, t_{RP}, t_{MRD}, t_{RRD}, t_{REFC}, t_{WR}) and memory configuration settings. This ensures compatibility with virtually any SDRAM configuration. CoreDDR is also available in netlist format with user-defined timing and memory configuration parameters for designs requiring low logic utilization or for designs requiring high-clock-rate operation. CoreDDR consists of the following primary blocks, as shown in Figure 1-2 on page 8:

- 1. Control and Timing Block Main controller logic
- 2. Initialization Control Performs initialization sequence after RESET_N is deactivated or SD_INIT is pulsed.
- 3. Address Generation Puts out address, bank address, and chip select signals on SDRAM interface.
- 4. Bank Management Keeps track of last opened row and bank to minimize command overhead.
- 5. Refresh Control Performs automatic refresh commands to maintain data integrity.
- 6. DDR Data Control Handles multiplexing and demultiplexing of data to and from the DDR SDRAM devices.

For the DDR SDRAM controller, the data passes through the controller, and the controller handles all DDR-related synchronization and timing generation. The DDR SDRAM controller uses a -90° phase-shifted system clock to capture read data in the center of the data window. The core also has separate DATAIN and DATAOUT busses at the user interface. These busses are twice as wide as the data bus going to the DDR SDRAM. This multiplexing is required because the local (user) interface operates at single data rate, whereas the SDRAM data interface operates at double data rate.

^{1.} The external tristate buffers shown in Figure 1-1 reside in the I/O. The output enables of the tristate buffers are controlled by CoreDDR.



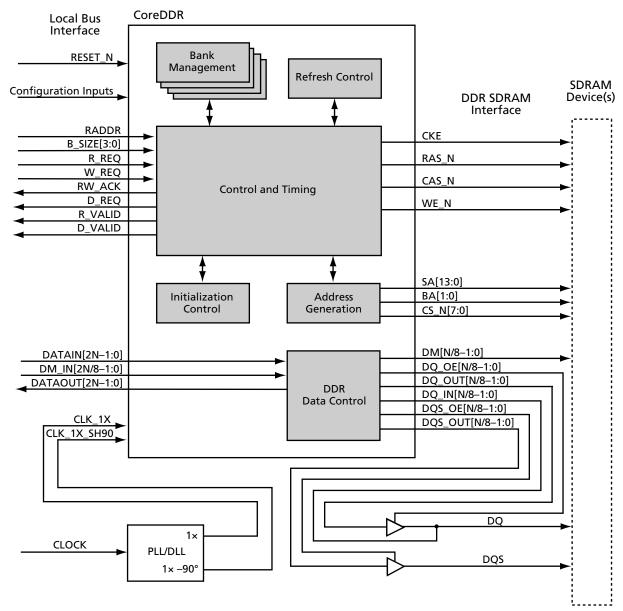


Figure 1-2 · DDR SDRAM Controller Block Diagram

CoreDDR v4.0 Address Mapping

Address Mapping

The mapping of the RADDR bus at the local bus interface to the chip select, row, column, and bank addresses is shown in Figure 1-3. The exact bit positions of the mapping will vary depending on the rowbits and colbits configuration port settings. The column bits, bank bits, row bits, and chip select are mapped from the least significant bits of RADDR. By mapping the bank bits from this location, long accesses to contiguous address space are more likely to take place without the need for a precharge.

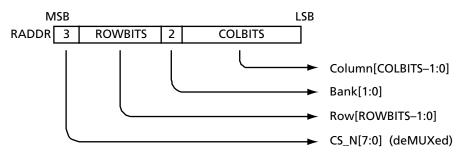


Figure 1-3 · Mapping of RADDR to SDRAM Chip Select, Row, Column, and Bank

CoreDDR Operation

The synchronous interface and fully pipelined internal architecture of SDRAM allow extremely fast data rates if used efficiently. SDRAM is organized in banks of memory addressed by row and column. The number of row and column address bits depends on the size and configuration of the memory.

SDRAM is controlled by bus commands formed using combinations of the RAS_N, CAS_N, and WE_N signals. For instance, on a clock cycle where all three signals are High, the associated command is a *no operation* (NOP). A NOP is also indicated when the chip select is not asserted. The standard SDRAM bus commands are shown in Table 1-1.

Command	RAS_N	CAS_N	WE_N
NOP	Н	Н	Н
Active	L	Н	Н
Read	Н	L	Н
Write	Н	L	L
Burst Terminate	Н	Н	L
Precharge	L	Н	L
Auto-Refresh	L	L	Н
Load Mode Register	L	L	L

Table 1-1 · SDRAM Bus Commands

SDRAM devices are typically divided into four banks. These banks must be opened before a range of addresses can be written to or read from. The row and bank to be opened are registered coincident with the *active* command. When a new row on a bank is accessed for a read or a write, it may be necessary to first close the bank and then reopen the bank to the new row. A bank is closed using the *precharge* command. Opening and closing banks costs memory bandwidth, so CoreDDR has been designed to monitor and manage the status of the four banks simultaneously. This enables the controller to intelligently open and close banks only when necessary.

When a *read* or *write* command is issued, the initial column address is presented to the SDRAM devices. In the case of DDR SDRAM, the initial data is presented one clock cycle after the *write* command. For the *read* command, the initial

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data appears on the data bus 1–4 clock cycles later. This delay, known as CAS latency, is due to the time required to physically read the internal DRAM and register the data on the bus. The CAS latency depends on the speed grade of the SDRAM and the frequency of the memory clock. In general, the faster the clock, the more cycles of CAS latency required.

After the initial *read* or *write* command, sequential reads and writes will continue until the burst length is reached or a *burst terminate* command is issued. SDRAM devices support a burst length of up to eight data cycles. The SDRAM controller is capable of cascading bursts to maximize SDRAM bandwidth.

SDRAM devices require periodic refresh operations to maintain the integrity of the stored data. CoreDDR automatically issues the *auto-refresh* command periodically. No user intervention is required.

The *load mode register* command is used to configure SDRAM operation. This register stores the CAS latency, burst length, burst type, and write burst mode. The SDRAM controller supports sequential burst type and programmed-length write burst mode. An additional extended mode register is used to control the integrated delay-locked loop (DLL) and the dq output drive strength. The DDR controller writes to the base mode register and extended mode register during the initialization sequence. Consult the SDRAM device specification for additional details on these registers.

Standard DDR Configurations

To reduce pin count, SDRAM row and column addresses are multiplexed on the same pins. Table 1-2 lists the number of rows, columns, banks, and chip selects required for various standard discrete DDR SDRAM devices. CoreDDR will support any of these devices.

SDRAM is typically available as dual in-line memory modules (DIMMs), small outline DIMMs (SO-DIMMs), and discrete chips. The number of row and column bits for a DIMM or SO-DIMM configuration can be found by determining the configuration of the discrete chips used on the module. This information is available in the module datasheet.

Chip Size	Configuration	Rows	Columns	Banks
64 MB	16M×4	12	10	4
64 MB	8M×8	12	9	4
64 MB	4M×16	12	8	4
64 MB	2M×32	11	8	4
128 MB	32M×4	12	11	4
128 MB	16M×8	12	10	4
128 MB	8M×16	12	9	4
128 MB	4M×32	12	8	4
256 MB	64M×4	13	11	4
256 MB	32M×8	13	10	4
256 MB	16M×16	13	9	4
512 MB	128M×4	13	12	4
512 MB	64M×8	13	11	4
512 MB	32M×16	13	10	4
1,024 MB	256M×4	14	12	4
1,024 MB	128M×8	14	11	4
1,024 MB	64M×16	14	10	4

Table 1-2 · Standard DDR SDRAM Device Configurations



CoreDDR v4.0 Instruction Timing

Instruction Timing

Initialization

After RESET_N is deasserted or SD_INIT is pulsed, CoreDDR performs the following sequence:

- 1. NOP command for 200 µs (delay controlled by the delay port parameter)
- 2. Precharge-all command
- 3. Extended load mode register command to enable the DDR SDRAM DLL
- 4. Load mode register command with DLL reset bit set
- 5. Precharge-all command
- 6. Two auto-refresh commands
- 7. Load mode register command with DLL reset bit clear and proper mode settings
- 8. Read/write requests held off for 200 clock cycles to allow for DLL to stabilize

CoreDDR initialization timing is shown in Figure 1-4.

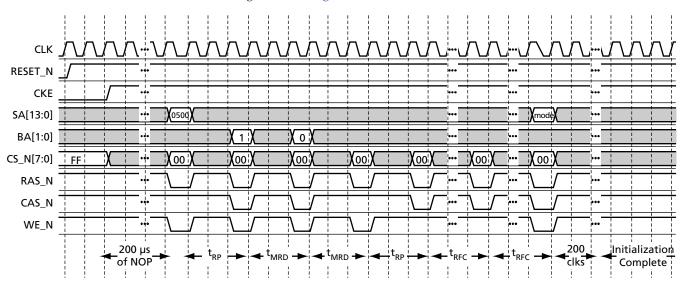


Figure 1-4 · DDR Initialization Sequence



Auto-Refresh

SDRAM devices require periodic *auto-refresh* commands to maintain data integrity. CoreDDR will automatically issue periodic *auto-refresh* commands to the SDRAM device(s) without user intervention.

The refresh period configuration port (REF) specifies the period between refreshes, in clock cycles. Figure 1-5 shows an example of two refresh commands. The first refresh sequence occurs when one or more banks have been left open as a result of a *read without precharge* or *write without precharge* operation. All open banks are closed using the *precharge-all* command (RAS_N, WE_N asserted with SA[10] and SA[8]) prior to the refresh command. In Figure 1-5, a refresh occurs again after the refresh period has elapsed, as determined using the REF configuration port. The refresh will never interrupt a read or write in the middle of a data burst. However, if the controller determines that the refresh period has elapsed at a point concurrent with or prior to a read or write request, the request may be held off (RW_ACK will not get asserted) until after the refresh has been performed.

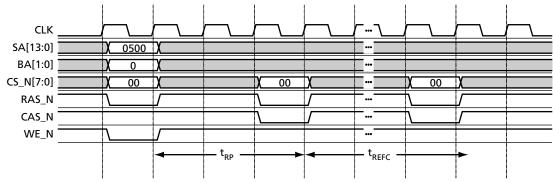


Figure 1-5 · Refresh Timing

Bank Management

CoreDDR incorporates bank management techniques to minimize command overhead. For each bank, the controller records the last opened row and whether the bank has been closed. When a local bus interface *read* or *write* request occurs, CoreDDR determines if the requested bank has already been opened and whether the request is for the same row as the one the bank is already opened to. If the bank is already opened to the requested row, CoreDDR performs the function immediately. If the bank was previously opened with a different row and was not closed, the controller closes the previously opened bank (using the *precharge* command) and reopens the bank (using the *active* command) to the requested row. If the bank is already closed, the controller opens the bank to the requested row (using the *active* command).

Requests to the controller can be issued as *read with auto-precharge*, *write with auto-precharge*, *read without auto-precharge*, and *write without auto-precharge*. Commands are issued with auto-precharge if the AUTO_PCH signal is set concurrent with the read request (R_REQ) or write request (W_REQ) signal. After a *read with auto-precharge* or *write with auto-precharge*, the accessed bank is automatically closed internally by the SDRAM devices. After a *read without auto-precharge* or *write without auto-precharge*, the accessed bank is left open until closing is required. Closing occurs whenever a request is issued to a row other than the one the bank is already open to, or during the next refresh sequence. The refresh sequence will close all the banks (using the *precharge-all* command) if all banks are not already closed.

The default configuration of the controller tracks the status of four banks at a time. This means that accesses to *row a* on *bank a* on *chip select a* is considered to be on a different row from *row a* on *bank a* on *chip select b*. Therefore, a close-and-open sequence is performed when switching between these rows.



Tool Flows

Licenses

CoreDDR is licensed in two ways. Depending on your license, tool flow functionality may be limited.

Obfuscated

Complete RTL code is provided for the core, enabling the core to be instantiated with SmartDesign. Simulation, synthesis, and layout can be performed with Actel Libero® Integrated Design Environment (IDE). The RTL code for the core is obfuscated, and some of the testbench source files are not provided. They are pre-compiled into the compiled simulation library instead.

RTL

Complete RTL source code is provided for the core and testbenches.

SmartDesign

The core can be configured using the configuration GUI within SmartDesign, as shown in Figure 2-1.

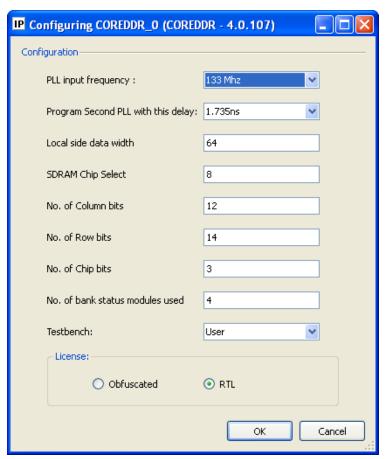


Figure 2-1 · CoreDDR Configuration Within SmartDesign



Tool Flows CoreDDR v4.0

Importing into Libero IDE

Libero IDE is available for download to the SmartDesign IP Catalog, via the Libero IDE web repository. For information on using SmartDesign to instantiate, configure, connect, and generate cores, refer to the Libero IDE online help.

Simulation Flows

To run simulations, select the user testbench within the SmartDesign CoreDDR configuration GUI, right-click, and select Generate Design.

When SmartDesign generates the design files, it will install the appropriate testbench files. To run the simulation, set the design root to the CoreDDR instantiation in the Libero IDE design hierarchy pane, and click the Simulation icon in the Libero IDE Design Flow window. This will invoke Model Sim® and automatically run the simulation.

Synthesis in Libero IDE

Set the design root appropriately and click the Synthesis icon in the Libero IDE. The Synthesis window appears, displaying the Synplicity® project. Set Synplicity to use the Verilog 2001 standard if Verilog is being used. To perform synthesis, click the **Run** icon.

Place-and-Route in Libero IDE

Having set the design root appropriately and run Synthesis, click the **Layout** icon in Actel Libero IDE to invoke Designer. CoreDDR requires no special place-and-route settings.



CoreDDR

Generics

Customers can define the generics listed in Table 3-1 as required in the source code.

Table 3-1 · CoreDDR Generics

Generic	Default Setting	Description	
		Must be set to match the supported FPGA family.	
FPGA family	16	16: ProASIC3E	
		17: Fusion	
PLL input frequency	133 MHz	The input frequency can be set to the following values: 33 MHz, 66 MHz, and 133 MHz.	
Program second PLL with this delay	1.335 ns	This delay is needed to capture the data properly. The data capture is explained in detail in "Implementation Hints" on page 29. The following delay values are supported: 0: Disable 1: 0.735 ns 2: 0.935 ns 3: 1.135 ns 4: 1.335 ns 5: 1.535 ns 6: 1.735 ns 7: 1.935 ns 8: 2.135 ns 9: 2.335 ns 10: 2.535 ns 11: 2.735 ns 12: 2.935 ns 13: 3.135 ns 14: 3.335 ns 15: 3.535 ns	
SDRAM_DSIZE	64	Local side data width	
SDRAM_CHIPS	8	Number of chip selects	
SDRAM_COLBITS	12	Maximum number of SDRAM column bits	
SDRAM_ROWBITS	14	Maximum number of SDRAM row bits	
SDRAM_CHIPBITS	3	Number of encoded chip select bits	
SDRAM_BANKSTATMODULES	4	Number of bank status modules used (in multiples of four)	
SDRAM_NIBBLE_DQS	0	For the DDR SDRAM controller, the typical configuration implements one dm and dqs per byte of dq bits. Some memories are arranged with one dm and one dqs per nibble of dq bits. CoreDDR can be configured to support one dm and one dqs per nibble of dq bits.	



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Controller Configuration Ports

CoreDDR is configured using runtime-programmable configuration ports. These ports may be tied off by the user to fixed values or programmed at runtime. These values should not change after RESET_N is deasserted. Table 3-2 lists the configuration ports.

Table 3-2 · CoreDDR Controller Parameters

Parameter	Port Bits	Valid Values	Description		
RAS	4	1–10	SDRAM active to precharge (t _{RAS}), specified in clock cycles		
RCD	3	2–5	SDRAM active to read or write delay (t _{RCD}), specified in clock cycles		
RRD	2	2–3	SDRAM active bank a to active bank b (t _{RRD}), specified in clock cycles		
RP	3	1–4	SDRAM precharge command period (t _{RP}), specified in clock cycles		
RC	4	3–12	SDRAM active to active/auto-refresh command period (t _{RC}), specified in clock cycles		
RFC	4	2–14	Auto-refresh to active/auto-refresh command period (t _{RFC}) specified in clock cycles		
MRD	3	1–7	SDRAM load mode register command to active or refresh command (t_{MRD}), specified in clock cycles		
CL	3	1–4	SDRAM CAS latency, specified in clock cycles		
CL_HALF	1	0–1	DDR SDRAM half clock latency. Specifies half clock of latency in addition to CL.		
BL	2	0–3	SDRAM maximum burst length (encoded). This value refers to the number of local side transfers per burst (one local side transfer results in two transfers to the DDR device). Values are decoded as follows: 0 – 1 transfer/burst 1 – 2 transfers/burst 2 – 4 transfers/burst 3 – 8 transfers/burst (valid for SDR SDRAM devices only)		
DS	2	0, 1, 3	DDR drive strength setting programmed into Extended Mode Register (EMR) bits 6 and 1. Values mapped to EMR as follows (refer to DDR SDRAM device datasheet for description of drive strength settings): 0 - EMR[6] = 0, EMR[1] = 0 1 - EMR[6] = 0, EMR[1] = 1 3 - EMR[6] = 1, EMR[1] = 1		
WR	2	1–3	SDRAM write recovery time (t _{WR})		
DELAY	16	10–65,535	Controller's delay after a reset event before initializing the SDRAM, specified in clock cycles. Per JEDEC standards, DDR devices require this delay to be a minimum of 200 μ s.		
REF	16	10-65,535	Period between auto-refresh commands issued by the controller, specified in clock cycles REF = auto-refresh interval/ $t_{\rm CK}$		
COLBITS	3	3–7	Number of bits in the column address (encoded). Values are decoded as follows: 3 – 8 column bits 4 – 9 column bits 5 – 10 column bits 6 – 11 column bits 7 – 12 column bits		

Parameter	Port Bits	Valid Values	Description
ROWBITS	2	0–3	Number of bits in the row address (encoded). Values are decoded as follows: $0-11$ row bits $1-12$ row bits $2-13$ row bits $3-14$ row bits
REGDIMM	1	0–1	Set when using registered/buffered DIMM. Causes adjustment in local bus interface timing to synchronize with SDRAM command timing, delayed by register/buffer on DIMM.

Table 3-2 · CoreDDR Controller Parameters (continued)

For example:

If RCD is 20 ns in the specification and the clock is 133 MHz, then the number of clocks is equal to $20 \div 7.5 = 3$. You must hardcode the RCD ports to the binary value "011" in the top level, since the value is "3". Example settings for the timing-related parameters are shown in Table 3-3. These settings are based on the speed grade of the SDRAM devices and the desired operating frequency. Consult the datasheet for the SDRAM device you are using for the specific timing values of that device.

Parameter	133 MHz (7.5 ns ₁	period) ¹	$167\mathrm{MHz}(6\mathrm{ns}\mathrm{period})^2$		$200 \mathrm{MHz} (5 \mathrm{ns}\mathrm{period})^3$	
Tarameter	Specification	Value	Specification	Value	Specification	Value
RAS	40.0 ns	6	42.0 ns	7	40.0 ns	8
RCD	20.0 ns	3	18.0 ns	3	15.0 ns	3
RRD	15.0 ns	2	12.0 ns	2	10.0 ns	2
RP	20.0 ns	3	18.0 ns	3	15.0 ns	3
RC	65.0 ns	9	60.0 ns	10	55.0 ns	11
RFC	75.0 ns	10	72.0 ns	12	70.0 ns	14
MRD	15.0 ns	2	12.0 ns	2	10.0 ns	2
CL	_	2	_	2	_	3
CL_HALF	_	1	_	1	_	0
WR	15.0 ns	2	15.0 ns	3	15.0 ns	2
DELAY	200 μs	26,667	200 μs	33,334	200 μs	40,000
REF	7.8125 μs	1,041	7.8125 μs	1,302	7.8125 μs	1,562

Table 3-3 · Example Controller Parameter Values for CoreDDR

Notes:

- 1. Values based on Micron MT46V64M8-75
- 2. Values based on Micron MT46V64m8-6T
- 3. Values based on Micron MT46V64M8-5B



Core Interfaces

The port signals for CoreDDR are defined in Table 4-1, Table 4-2 on page 20, and Table 3-2 on page 16, and illustrated in Figure 1-3 on page 9. All signals are designated either Input (input only) or Output (output only).

Local Bus Signals

The user interface to CoreDDR is referred to as the local bus interface. The local bus signals are shown in Table 4-1.

Table 4-1 · Local Bus Signals

Signal	Name	I/O	Description
CLK_IN	Clock	Input	System input clock. All local interface signals are synchronous to this clock.
CLK_1X	Clock	Output	1× system clock.
CLK_1X_SH90	Clock	Output	A 90° phase-shifted version of system clock
RESET_N	Reset	Input	System reset
RADDR[30:0]	Memory Address	Input	Local interface address
B_SIZE[3:0]	Burst Size	Input	Local interface burst length. Valid values are 1 through BL, where BL is the programmed burst length. (Refer to Table 3-2 on page 16 for a discussion of the BL parameter.)
R_REQ_	Read Request	Input	Local interface read request
W_REQ_	Write Request	Input	Local interface write request
AUTO_PCH	Auto-Precharge Request	Input	When asserted in conjunction with R_REQ or W_REQ, causes command to be issued as <i>read with auto-precharge</i> or <i>write with auto-precharge</i> , respectively.
RW_ACK	Read/Write Acknowledge	Output	Acknowledgment of read or write request
D_REQ_	Data Request	Output	Requests data on the local interface write data bus (datain) during a write transaction. Asserts one clock cycle prior to when data is required.
W_VALID	Write Data Valid	Output	Frames the active data being written to SDRAM. Mimics D_REQ, except it is delayed by one clock cycle.
			This signal is typically not used and is retained for legacy compatibility.
R_VALID	Read Data Valid	Output	Indicates that the data on the local interface read data bus (dataout) is valid during a read cycle.
			Causes the SDRAM controller to reissue the initialization sequence to SDRAM devices.
SD_INIT	Initialization Strobe	Input	The SDRAM controller will always issue the initialization sequence (including the startup delay) after reset, regardless of the SD_INIT state. This signal can be tied Low if runtime reinitialization is not required.
DATAIN[2N-1:0]	Input Data	Input	Input data bus. This data bus is twice the width of the DDR SDRAM data bus.
DATAOUT[2N-1:0]	Output Data	Output	Output data bus. This data bus is twice the width of the DDR SDRAM data bus.
DM_IN[2N/16-1:0]	Data Mask	Input	Masks individual bytes during data write.

Notes:

- 1. The N value in vector indexing refers to data width to SDRAM interface.
- 2. All control signals are active high except RESET_N.
- 3. All local interface signals are synchronous to CLK_1X.



Core Interfaces CoreDDR v4.0

DDR SDRAM Interface Signals

The external interface to SDRAM devices is referred to as the SDRAM interface. The SDRAM interface signals are shown in Table 4-2.

Table 4-2 · DDR SDRAM Interface Signals

Signal	Name	I/O	Description
SA[13:0]	Address Bus	Output	Sampled during the <i>active</i> , <i>precharge</i> , <i>read</i> , and <i>write</i> commands. This bus also provides the mode register value during the <i>load mode register</i> command.
BA[1:0]	Bank Address	Output	Sampled during <i>active</i> , <i>precharge</i> , <i>read</i> , and <i>write</i> commands to determine which bank command is to be applied to.
CS_N[7:0]	Chip Selects	Output	SDRAM chip selects
CKE	Clock Enable	Output	SDRAM clock enable. Held Low during reset to ensure SDRAM DQ and DQS outputs are in the high-impedance state.
RAS_N	Row Address Strobe	Output	Command input
CAS_N	Column Address Strobe	Output	Command input
WE_N	Write Enable	Output	Command input
DQ_OUT[N-1:0]	Data Bus Output	Output	SDRAM data bus output to external tristate buffers. This data bus is half the width of the DATAIN and DATAOUT busses.
DQIN[N-1:0]	Data Bus Input	Input	SDRAM data bus input. This data bus is half the width of the DATAIN and DATAOUT busses.
DQ_OE[N/8-1:0]	Data Bus Output Enable	Output	SDRAM data bus output enable. Used to control external tristate buffers to DDR SDRAM.
DM[N/8-1:0]	Data Mask	Output	Masks individual bytes during data write. Multiplexed version of the DM_IN input to the controller.
DQS_OUT[N/8-1:0]	Data Strobe Output	Output	Strobes data into the SDRAM devices during writes.
DQS_OE[N/8-1:0]	Data Strobe Output Enable	Output	Used to control external tristate buffers for data strobe.

Notes:

- 1. The n value in vector indexing refers to data width to SDRAM interface.
- 2. All control signals are active high except RESET_N.
- 3. All local interface signals are synchronous to CLK_1X.



Timing Diagrams

SDRAM Writes

The user requests writes to the local bus interface by asserting the W_REQ signal and driving the starting address and burst size on RADDR and B_SIZE, respectively. The AUTO_PCH signal can also be asserted with W_REQ to cause the write to be issued as a *write with auto-precharge*.

The rules for write requests to the local bus interface are as follows:

- Once W_REQ is asserted, it must remain asserted until RW_ACK is asserted by CoreDDR. After RW_ACK is
 asserted by CoreDDR, W_REQ may remain asserted to request a follow-on write transaction. W_REQ may remain
 asserted over any number of RW_ACK pulses to generate any number of cascaded write bursts. The only time
 W_REQ may be deasserted is during the clock cycle immediately following the RW_ACK pulse from CoreDDR.
- 2. RADDR, B_SIZE, and AUTO_PCH must maintain static values from the point when W_REQ becomes asserted until CoreDDR asserts RW_ACK. RADDR, B_SIZE, and AUTO_PCH may only change values in the clock cycle immediately following the RW_ACK pulse from CoreDDR, or when W_REQ is deasserted.
- 3. The W_REQ signal may not be asserted while the read request (R_REQ) signal is asserted.
- 4. The data request (D_REQ) signal will assert one clock cycle prior to when the user must present data on the DATAIN bus.
- 5. The timing relationship between an initial W_REQ and RW_ACK assertion, or between RW_ACK pulses as a result of multiple cascaded writes, will vary depending on the status of the banks being accessed, configuration port settings, refresh status, and initialization status. The user logic should not rely on any fixed timing relationship between W_REQ and RW_ACK.

Example CoreDDR Write Sequence

Figure 5-1 on page 22 shows an example DDR SDRAM controller write sequence. In this sequence, three writes are requested, all to the same row. The first and second write requests are for a burst size of four, and the third is for a burst size of two. The write request (W_REQ) signal is first asserted along with the starting address (RADDR) and the burst size (B_SIZE). As a result of this request, the DDR SDRAM controller asserts the row address (SA), bank address (BA), and chip select (CS_N) with the *active* command to open the bank to the requested row. Next, the DDR SDRAM controller requests data from the user through the local interface using the D_REQ signal, and acknowledges the write request by asserting RW_ACK. The DDR SDRAM controller begins writing the data to the SDRAM devices by issuing the *write* command and presenting the DDR data and the DQS clock. For this request, four data transfers occur to the local interface, which translates to eight data transfers to the SDRAM interface.

The local interface write request (W_REQ) remains asserted after RW_ACK asserted by the DDR SDRAM controller to request an additional write burst. After the rw_ack pulse, the local interface changes the address (RADDR) but keeps the burst size (B_SIZE) at four. The DDR SDRAM controller issues the next *write* command, and data transfers to the SDRAM interface immediately following the first burst.

After the second write request, the DDR SDRAM controller continues to assert W_REQ to cause a third burst. For this write, the burst size (B_SIZE) is reduced to two. Since the burst size of the second write request is less than the programmed DDR SDRAM burst length, the DDR SDRAM controller must prevent the last data transfers from being written to memory. DDR SDRAM devices do not allow write bursts to be terminated, so the DDR SDRAM controller handles this by masking the last four data transfers (using dm) to prevent these from being written to the SDRAM.

In the case of this write burst sequence, all the writes are to the same bank and row. If the second or third writes are to different banks or rows, the SDRAM controller issues *precharge* and/or *active* commands prior to the *write* commands.

Timing Diagrams CoreDDR v4.0

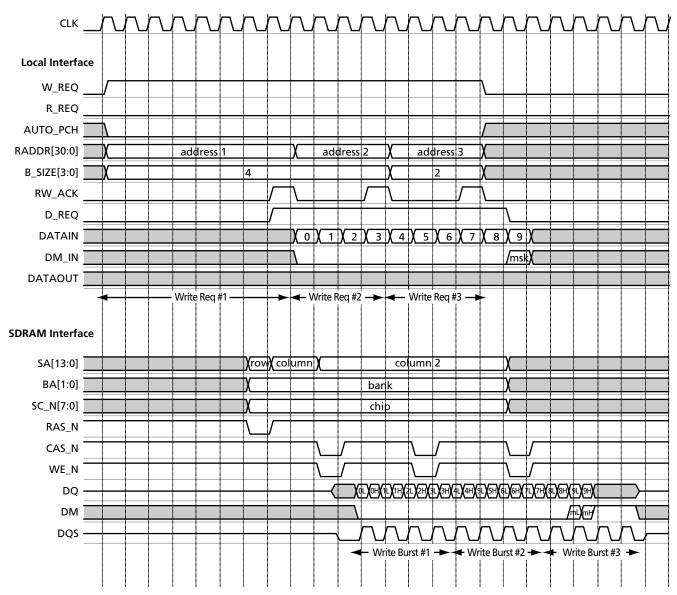


Figure 5-1 · CoreDDR Burst Write



CoreDDR v4.0 SDRAM Reads

SDRAM Reads

The user requests reads from the local bus interface by asserting the R_REQ signal and driving the starting address and burst size on RADDR and B_SIZE, respectively. The AUTO_PCH signal can also be asserted with R_REQ to cause the read to be issued as a *read with auto-precharge*.

The rules for read requests at the local bus interface are as follows:

- Once R-REQ is asserted, it must remain asserted until RW_ACK is asserted by CoreDDR. After RW_ACK is asserted by CoreDDR, R_REQ may remain asserted to request a follow-on read transaction. R_REQ may remain asserted over any number of RW_ACK pulses to generate any number of cascaded read bursts. The only time R_REQ may be deasserted is during the clock cycle immediately following the RW_ACK pulse from CoreDDR.
- 2. RADDR, B_SIZE, and AUTO_PCH must maintain static values from the point when R_REQ becomes asserted until CoreDDR asserts RW_ACK. RADDR, B_SIZE, and AUTO_PCH may only change values in the clock cycle immediately following the RW_ACK pulse from CoreDDR, or when R-REQ is deasserted.
- 3. The R-REQ signal may not be asserted while the write request (W_REQ) signal is asserted.
- 4. The read data valid (R_VALID) signal will assert when valid data is available on the DATAOUT bus.

The timing relationship between an initial R_REQ and RW_ACK assertion, or between RW_ACK pulses as a result of multiple cascaded reads, will vary depending on the status of the banks being accessed, configuration port settings, refresh status and initialization status. The user logic should not rely on any fixed timing relationship between R_REQ and RW_ACK.

Example CoreDDR Read Sequence

Figure 5-2 on page 24 shows an example DDR SDRAM controller read sequence. In this sequence, three reads are requested, all from the same row. The first and second read requests are for a burst size of four, and the third is for a burst size of two. The read request (R_REQ) signal is first asserted with the starting address (RADDR) and the burst size (B_SIZE). As a result of this request, the DDR SDRAM controller asserts the row address (SA), bank address (BA), and chip select (CS_N) with the *active* command to open the bank to the requested row. Next, the DDR SDRAM controller acknowledges the read request by asserting RW_ACK, then issues the *read* command to the SDRAM devices. Since the CAS latency is set at 2.5 in this case, read data appears at the SDRAM interface 2.5 clock cycles after the *read* command is issued. The DDR SDRAM controller demultiplexes the data at the SDRAM interface and presents it to the local interface dataout bus. The DDR SDRAM controller asserts the R_VALID signal to indicate valid data to the DATAOUT bus. For this request, eight data transfers occur at the SDRAM interface, which translates to four data transfers to the local interface.

The local interface read request (R_REQ) remains asserted after RW_ACK is asserted by the DDR SDRAM controller to request an additional read burst. After the RW_ACK pulse, the local interface changes the address (RADDR) but keeps the burst size (B_SIZE) at four. The DDR SDRAM controller issues the next *read* command, and data transfers at the SDRAM interface immediately following the first burst.

After the second read request, the DDR SDRAM controller continues to assert R_REQ to cause a third burst. For this write, the burst size (B_SIZE) is reduced to two. Since the burst size of the second read request is less than the programmed DDR SDRAM burst length, the burst must be terminated using the *burst terminate* command. The DDR SDRAM controller does this automatically, asserting CAS_N two clock cycles after the *read* command was issued. This causes the SDRAM devices to discontinue the read after the first four data transfers to the SDRAM interface. The SDRAM devices also stop driving the DQS clock signal.

Timing Diagrams CoreDDR v4.0

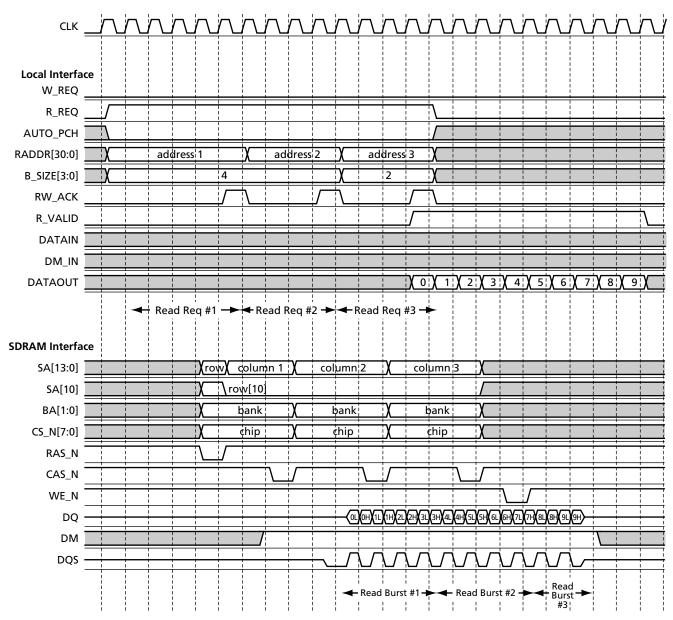


Figure 5-2 · CoreDDR Burst Read



CoreDDR v4.0 Auto-Precharge

Auto-Precharge

Read commands can be issued to the SDRAM devices as read with auto-precharge or read without auto-precharge. Likewise, write commands can be issued to the SDRAM devices as write with auto-precharge or write without auto-precharge. If the auto-precharge option is used, the SDRAM device will automatically close (precharge) banks being read from or written to at the end of the transaction. Any subsequent reads or writes to this bank will not require an explicit precharge command from CoreDDR.

The user selects whether *read* or *write* commands are issued with auto-precharge through the AUTO_PCH signal. If AUTO_PCH is asserted along with W_REQ or R_REQ, the command will be issued to the SDRAM with auto-precharge. The auto-precharge option is useful in situations where the requested read or write addresses tend to be random. With random address sequences, banks are seldom left open with the exact row required by a subsequent request. If auto-precharge is not used for the previous access to a bank, subsequent transactions to that bank first require the bank to be closed (precharged), causing a delay in the transaction. If auto-precharge is used for the previous access, the bank is already closed and ready to be opened to the desired row.

Figure 5-3 on page 26 shows example transactions using the auto-precharge feature of CoreDDR. In the example, two write requests are issued, the first using auto-precharge and the second not using auto-precharge. Both requests are to the same bank but may be to different rows. CoreDDR issues the first command as a write with auto-precharge by driving bit SA[10] High during the write command. CoreDDR issues the second command as a write without auto-precharge by driving bit SA[10] Low during the write command. Since the first and second requests are to the same bank, CoreDDR must wait before reopening the bank to meet the SDRAM twR and tRP requirements. Had the first and second requests been to different banks, the second request would have followed the first request with no interruption to data flow.

Timing Diagrams CoreDDR v4.0

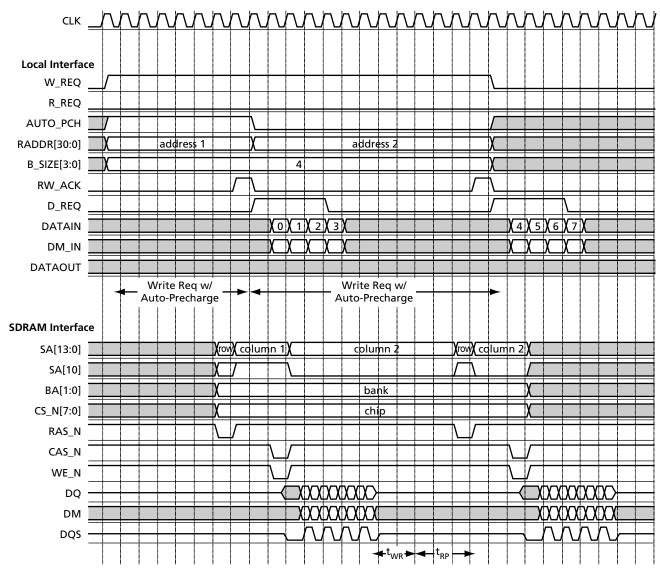


Figure 5-3 · CoreDDR Burst Writes with Auto-Precharge Option



Testbench Operation

Two testbenches are provided with CoreDDR:

- · Verilog testbench
- VHDL testbench

Testbench Description

Included with the Obfuscated and RTL releases of CoreDDR is a user testbench that gives an example of CoreDDR usage. A simplified block diagram of the testbench is shown in Figure 6-1. By default, the Verilog version, tb_user.v, instantiates a Micron SDRAM model (mt46v8m16.v). The VHDL version, tb_user.vhd, instantiates a Micron SDRAM model (mt46v8m16.vhd). The testbench instantiates the DUT (design under test), which is the CoreDDR macro, the SDRAM model, as well as the test vector modules that provide stimuli sources for the DUT. A procedural testbench controls each module and applies the sequential stimuli to the DUT.

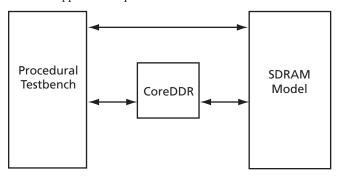


Figure 6-1 · CoreDDR Testbench

Verilog User Testbench

The Verilog user testbench is provided as a reference and can be modified to suit your needs. The source code for the Verilog user testbench is provided to ease the process of integrating the CoreDDR macro into your design and verifying its functionality.

VHDL User Testbench

The VHDL user testbench is provided as a reference and can be modified to suit your needs. The source code for the VHDL testbench is provided to ease the process of integrating the CoreDDR macro into your design and verifying its functionality.



Implementation Hints

Data Capture

There are two ways of achieving data capture with DDR: self-timed and by use of the Distributed Queueing System (DQS) strobes. Due to lack of multiple DLL elements in ProASIC3E technology and the relatively low speeds (<200 MHz), Actel recommends the self-timed approach.

Handling the Data Capture from DIMM

Self-timed mode requires the controller to generate a data sample clock that captures the incoming data (Figure 7-1). Ideally this is 90° phase-shifted from the main clock; in reality, allowance has to be made for propagation delays. The DIMM (DDRRAM) generates data on both the positive and negative clock edges. The secondary clock of the PLL is ideally a 90° phase-shifted clock and needs to sample the data correctly. When capturing data, the 90° phase-shifted clock should sample the data clock to the mid point of the data window.

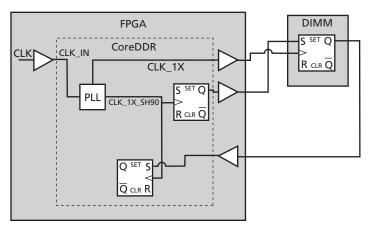


Figure 7-1 · Self-Timed Mode

The DIMM (DDRRAM) generates data on both the positive and negative clock edges. The FPGA will ideally clock on the 90° phase-shifted clock and correctly sample the data. Due to the propagation delays, however, the data is not captured correctly. The 90° phase-shifted clock is replaced with the CLKDLY cell to adjust the delay values and capture the data properly, as shown in Figure 7-3 on page 30.

The best and worst case signal propagation delays are calculated in "Delay Calculation" on page 30. In the ProASIC3E-2 part, the data round trip delay from the internal clock to the data arriving at the sample register at worst case conditions is 4.85 ns. The best case conditions is 2.5 ns (Figure 7-2).

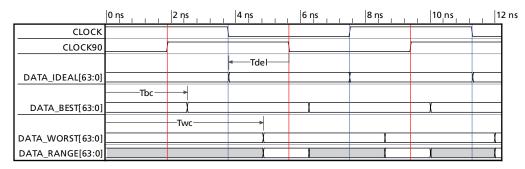


Figure 7-2 \cdot Signal Propagation Delays

29

EQ 7-1

Implementation Hints CoreDDR v4.0

Note: In Figure 7-2 on page 29 we assume that the secondary clock, which has a phase shift of 90°, is ideal. The sample points (rising edge and falling edge) are in red. The DATA_BEST shows the fastest that the data can change (2.5 ns round trip) and DATA_WORST the slowest (4.85 ns round trip). The DATA_RANGE indicates when the data should be valid at the capture register. What we want to achieve is that the sample clock hits the midpoint of the data window. EQ 7-1 is the equation for calculating the clock delay (for the CLKDLY cell in the ProASIC3E FPGA cell library) to achieve this midpoint sample.

Definitions

Tbc = Best case data round trip delay

Twc = Worst case round trip delay

Tclk = System clock period

Tdel = Delay needed to shift the capture clock

DLL Delay =
$$(Tclk/2 + Tbc + Twc)/2 - Tclk/2$$

= (Tclk/2 + Tbc + Twc - Tclk)/2

= (Tbc + Twc - Tclk/2)/2

Using typical figures obtained with an A3PE600FG484-2 part and a socketed, mounted 1 GB DIMM module we get

=(2.5 + 4.85 - 3.75)/2

Tdel = 1.8 ns (equivalent to 86° shift from the system clock)

From EQ 7-1, the Clock Delay macro should be generated with a delay of 1.8 ns to capture the data correctly, as shown in Figure 7-3.

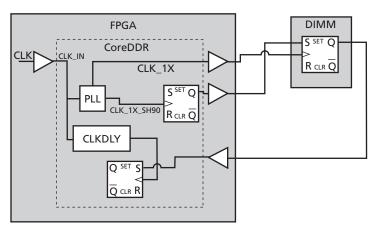


Figure 7-3 · Data Capture

Delay Calculation

Worst Case Delay Calculation

- CLK output PAD = 1.6 ns
- 2. PCB Delay to DIMM = 0.61 ns
- 3. CLKK_OUT on DIMM = 0.75 ns
- 4. PCB Delay to FPGA = 0.6 1 ns



CoreDDR v4.0 Data Capture

- 5. Input PAD Delay to DDR Reg = 0.996 ns
- 6. Setup at DDR Reg = 0.282 ns

Adding the numbers from 1 through 6 gives a worst case delay of 4.85 ns.

Best Case Delay Calculation

- 1. CLK to output PAD = 0.86 ns
- 2. PCB Delay to DIMM = 0.43 ns
- 3. CLK_OUT on DIMM = 0 ns
- 4. PCB Delay to FPGA = 0.43 ns
- 5. Input PAD Delay to DDR Reg = 0.6 ns
- 6. Setup at DDR Reg = 0.203 ns

Adding the numbers from 1 through 6 gives a best case delay of 2.5 ns.



Ordering Information

Ordering Codes

CoreDDR can be ordered through your local Actel sales representative. It should be ordered using the following number scheme: CoreDDR-XX, where XX is listed in Table 8-1.

Table 8-1 · Ordering Codes

XX	Description
OM	RTL for Obfuscated RTL – multiple-use license
RM	RTL for RTL source – multiple-use license

Note: CoreDDR-OM is included free with a Libero IDE license.





List of Document Changes

The following table lists critical changes that were made in the current version of the document.

Previous Version	Changes in Current Version ()	Page
v2.2	The signal names were all made upper case.	N/A
	The buffers were removed from Figure 1-1 · Typical CoreDDR System. They are depicted more completely in Figure 1-2 · DDR SDRAM Controller Block Diagram.	7
	The "Address Mapping" section was revised to state that column bits, bank bits, row bits, and chip select are mapped from the least significant bits of RADDR.	9
	Figure 2-1 · CoreDDR Configuration Within SmartDesign was replaced.	13
	Table 3-1 · CoreDDR Generics was revised to remove the parameters SDRAM_BANKS, SDRAM_OE_BITS, and SDRAM_BANKBITS, and SDRAM_RASIZE. The default setting for "Program second PLL with this delay" was changed to 1.335 ns.	15
	The text preceding Table 3-3 · Example Controller Parameter Values for CoreDDR was revised.	17
	The description for CLK_1X_SH90 in Table 4-1 · Local Bus Signals was revised to change -90° to 90°.	19
	The "SDRAM Reads" section was revised to correct errors in points 1 and 3 so that "read" is used with the R_REQ signal and "write" with the W_REQ signal.	23
v2.1	The core version was changed from v3.0 to v4.0	N/A
	The "Key Features" section is new.	5
	Fusion was added to the "Supported Device Families" section.	5
	Table 1 · CoreDDR Device Utilization and Performance was expanded to include Fusion.	5
	The "Tool Flows" section was revised. The Evaluation version is no longer available. CoreConsole was replaced by SmartDesign.	13
	Table 3-1 · CoreDDR Generics was revised to add Fusion as an available setting for the FPGA Family generic.	15
	"Testbench Description" section was revised.	27
	The "Verilog Testbench" section was replaced by the "Verilog User Testbench" section. The "VHDL Testbench" section was replaced by the "VHDL User Testbench" section.	27
	The "Ordering Information" chapter is new.	33
v2.0	The "Supported Device Families" section was added.	5



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